TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

2SC4317

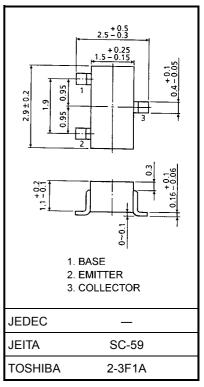
VHF~UHF Band Low Noise Amplifier Applications

Unit: mm

- Low noise figure, high gain.
- NF = 1.1dB, $|S_{21e}|^2 = 13dB$ (f = 1 GHz)

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Collector-base voltage	V_{CBO}	20	V	
Collector-emitter voltage	V _{CEO}	10	V	
Emitter-base voltage	V _{EBO}	1.5	V	
Base current	Ι _Β	20	mA	
Collector current	I _C	40	mA	
Collector power dissipation	PC	150	mW	
Junction temperature	Tj	125	°C	
Storage temperature range	T _{stg}	−55~125	°C	



Weight: 0.012 g (typ.)

Microwave Characteristics (Ta = 25°C)

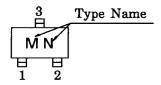
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Transition frequency	f _T	$V_{CE} = 8 \text{ V}, I_{C} = 20 \text{ mA}$	7	10	_	GHz	
Insertion gain	S _{21e} ² (1)	V _{CE} = 8 V, I _C = 20 mA, f = 1 GHz		13	_	dB	
insertion gain	S _{21e} ² (2)	$V_{CE} = 8 \text{ V}, I_{C} = 20 \text{ mA}, f = 2 \text{ GHz}$		7 — db			
Noise figure	NF (1)	$V_{CE} = 8 \text{ V}, I_{C} = 5 \text{ mA}, f = 1 \text{ GHz}$	_	1.1	2.5	dB	
Noise liguie	NF (2)	$V_{CE} = 8 \text{ V}, I_{C} = 5 \text{ mA}, f = 2 \text{ GHz}$		1.7	_	ub	

Electrical Characteristics (Ta = 25°C)

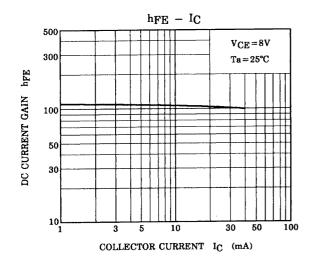
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I _{CBO}	$V_{CB} = 10 \text{ V}, I_{E} = 0$	_	_	1	μА
Emitter cut-off current	I _{EBO}	V _{EB} = 1 V, I _C = 0	_	_	1	μА
DC current gain	h _{FE}	V _{CE} = 8 V, I _C = 20 mA	50	_	250	
Output capacitance	C _{ob}	V _{CB} = 10 V, I _F = 0, f = 1 MHz (Note)	_	0.65	_	pF
Reverse transfer capacitance	C _{re}	$\frac{1}{2}$ $A \cap A$		0.45	0.9	pF

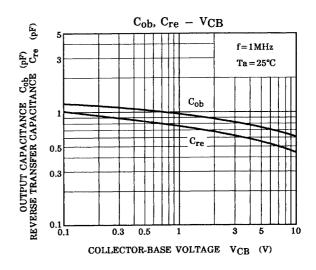
Note: C_{re} is measured by 3 terminal method with capacitance bridge.

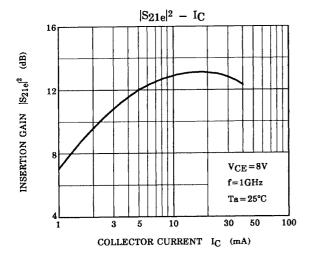
Marking

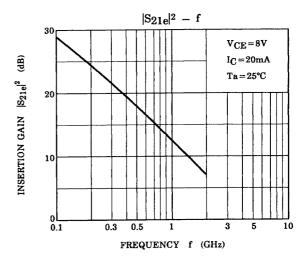


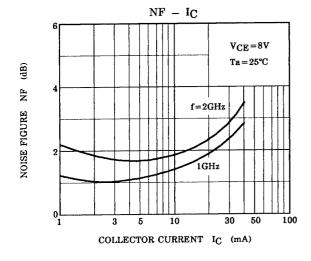
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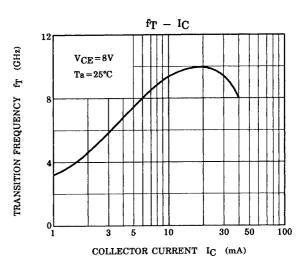




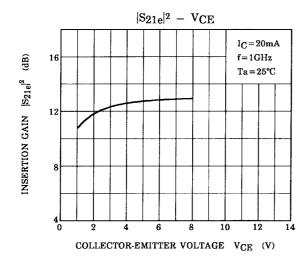


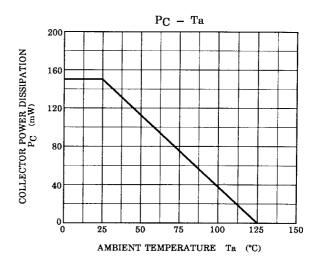






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S-Parameter $Z_0 = 50 \Omega$, Ta = 25°C

$V_{\text{CE}} = 8 \text{ V, } I_{\text{C}} = 5 \text{ mA}$

Frequency	S	11	S2	21	S	12	S2	22
MHz	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
200	0.649	-46.9	11.454	139.7	0.044	67.8	0.823	-26.1
400	0.426	-78.5	8.028	116.2	0.068	61.0	0.623	-36.4
600	0.282	-100.9	5.965	102.6	0.085	60.4	0.513	-39.5
800	0.192	-122.5	4.688	92.7	0.103	61.5	0.452	-40.3
1000	0.131	-147.7	3.856	85.4	0.121	62.6	0.422	-41.1
1200	0.099	-175.5	3.308	78.9	0.140	63.2	0.406	-42.0
1400	0.096	145.6	2.871	72.7	0.159	63.2	0.404	-43.5
1600	0.091	116.0	2.562	68.0	0.179	63.0	0.402	-45.9
1800	0.111	93.4	2.341	62.9	0.199	62.5	0.406	-49.1
2000	0.115	78.3	2.106	59.5	0.218	62.0	0.409	-53.1

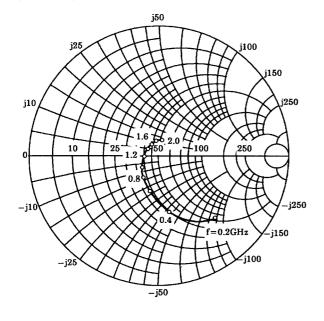
$V_{CE}=8\ V,\ I_{C}=20\ mA$

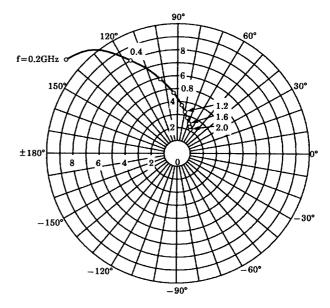
Frequency	S11		S21		S12		S22	
MHz	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
200	0.278	-78.9	18.400	118.0	0.031	71.1	0.586	-33.3
400	0.138	-120.1	10.350	99.6	0.053	73.5	0.426	-32.4
600	0.088	-159.6	7.137	90.4	0.076	74.1	0.379	-30.1
800	0.084	157.2	5.433	83.4	0.100	73.9	0.361	-29.1
1000	0.096	122.5	4.401	78.0	0.123	73.1	0.356	-29.7
1200	0.117	99.7	3.719	73.0	0.147	71.5	0.357	-31.3
1400	0.141	84.9	3.216	67.9	0.170	69.9	0.364	-33.6
1600	0.152	69.0	2.849	63.9	0.192	68.3	0.372	-37.0
1800	0.167	59.2	2.577	59.6	0.215	66.3	0.381	-41.3
2000	0.169	49.4	2.304	56.3	0.235	64.7	0.386	-46.3

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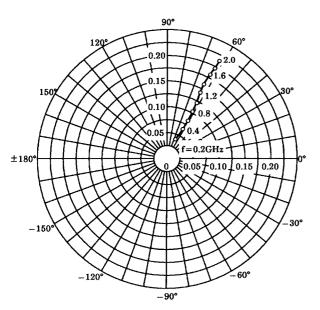
 $\begin{array}{l} S_{11e} \\ V_{CE} = 8V \\ I_{C} = 5mA \\ Ta = 25^{\circ}C \\ (UNIT:\Omega) \end{array}$



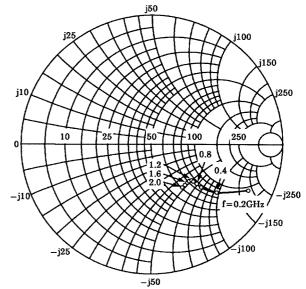




 $\begin{array}{c} S_{12e} \\ V_{CE} = 8V \\ I_{C} = 5\text{mA} \\ Ta = 25^{\circ}C \end{array}$

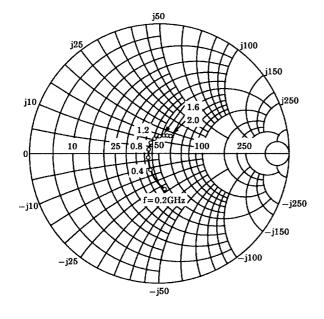


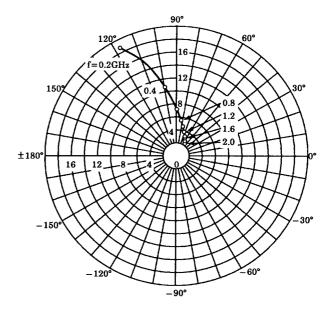
 $\begin{array}{l} S_{22e} \\ V_{CE} = 8V \\ I_{C} = 5mA \\ Ta = 25^{\circ}C \\ (UNIT:\Omega) \end{array}$



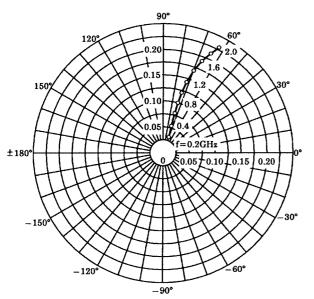
 $\begin{array}{l} S_{11e} \\ V_{CE} = 8V \\ I_{C} = 20 mA \\ Ta = 25 ^{\circ}C \\ (UNIT: \Omega) \end{array}$

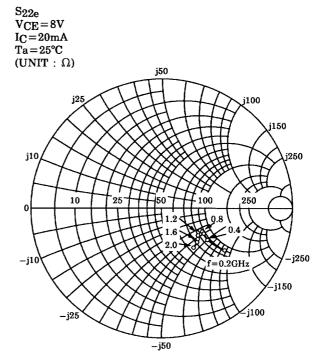






 $\begin{array}{l} S_{12e} \\ V_{CE} = 8V \\ I_{C} = 20 \text{mA} \\ T_{a} = 25 ^{\circ}C \end{array}$





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